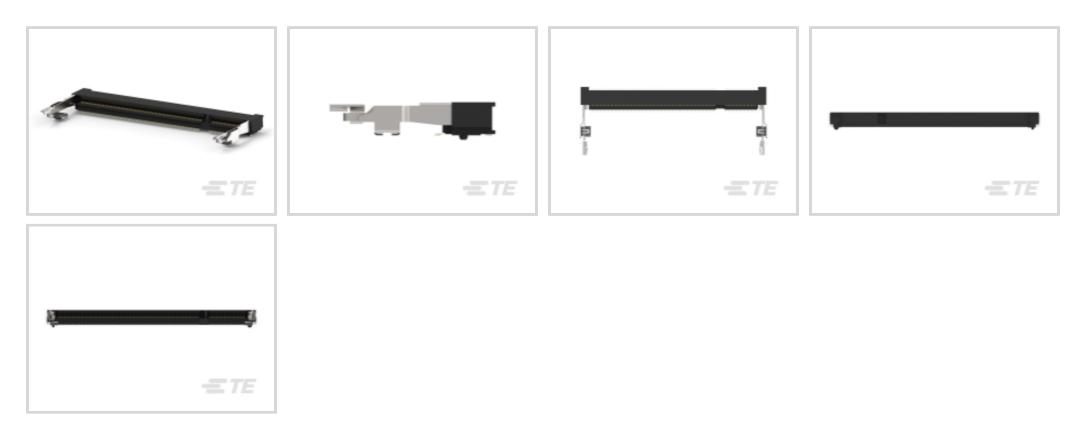


TE Internal #: 1473005-1 SO DIMM Sockets, Double Data Rate (DDR), Stack Height .205 in [5.2 mm], Right Angle Module Orientation, 200 Position, .024 in [.6 mm] Centerline

#### View on TE.com >

Connectors > Socket Connectors > Memory Sockets > SO DIMM Sockets > DDR2 SO DIMM Sockets



DRAM Type: Double Data Rate (DDR) Stack Height: 5.2 mm [.205 in ] Module Orientation: Right Angle Connector System: Cable-to-Board Number of Positions: 200

All DDR2 SO DIMM Sockets (30)



# Features

### Product Type Features

DRAM Type	Double Data Rate (DDR)	
Connector System	Cable-to-Board	
Connector & Contact Terminates To	Printed Circuit Board	
Configuration Features		
Number of Bays	2	
Number of Keys	1	
Number of Rows	2	
Module Orientation	Right Angle	
Number of Positions	200	
Electrical Characteristics		
DRAM Voltage	2.5 V	
Signal Characteristics		
SGRAM Voltage	2.5 V	

connectivity

SO DIMM Sockets, Double Data Rate (DDR), Stack Height .205 in [5.2 mm], Right Angle Module Orientation, 200 Position, .024 in [.6 mm] Centerline



## **Body Features**

Ejector Location	Both Ends
Latch Material	Stainless Steel
Latch Plating Material	Tin
Module Key Type	SGRAM
Ejector Type	Locking
Connector Profile	Standard
Contact Features	
Memory Socket Type	Memory Card
PCB Contact Termination Area Plating Material	Gold Flash
Contact Base Material	Copper Alloy
Contact Mating Area Plating Material	Gold Flash
Contact Current Rating (Max)	.5 A
Termination Features	
Insertion Style	Cam-In
Mechanical Attachment	
Mating Alignment Type	Standard Keying
PCB Mounting Style	Surface Mount
PCB Mount Retention	With
PCB Mount Retention Type	Solder Peg
Connector Mounting Type	Board Mount
Housing Features	
Housing Material	High Temperature Thermoplastic
Housing Color	Black
Centerline (Pitch)	.6 mm[.024 in]
Dimensions	
Stack Height	5.2 mm[.205 in]
Row-to-Row Spacing	6.2 mm[.244 in]
Usage Conditions	
Operating Temperature Range	-55 – 85 °C[-67 – 185 °F]
Operation/Application	

**C** For support call+1 800 522 6752

SO DIMM Sockets, Double Data Rate (DDR), Stack Height .205 in [5.2 mm], Right Angle Module Orientation, 200 Position, .024 in [.6 mm] Centerline



Industry Standards	
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Quantity	20
Packaging Method	Semi-Hard Tray Assembly
Product Compliance For compliance documentation, visit the product page on TE.com>	
EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUNE 2023 (235) Does not contain REACH SVHC
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Canability	Reflow solder canable to 215°C

Reflow solder capable to 245°C

#### Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

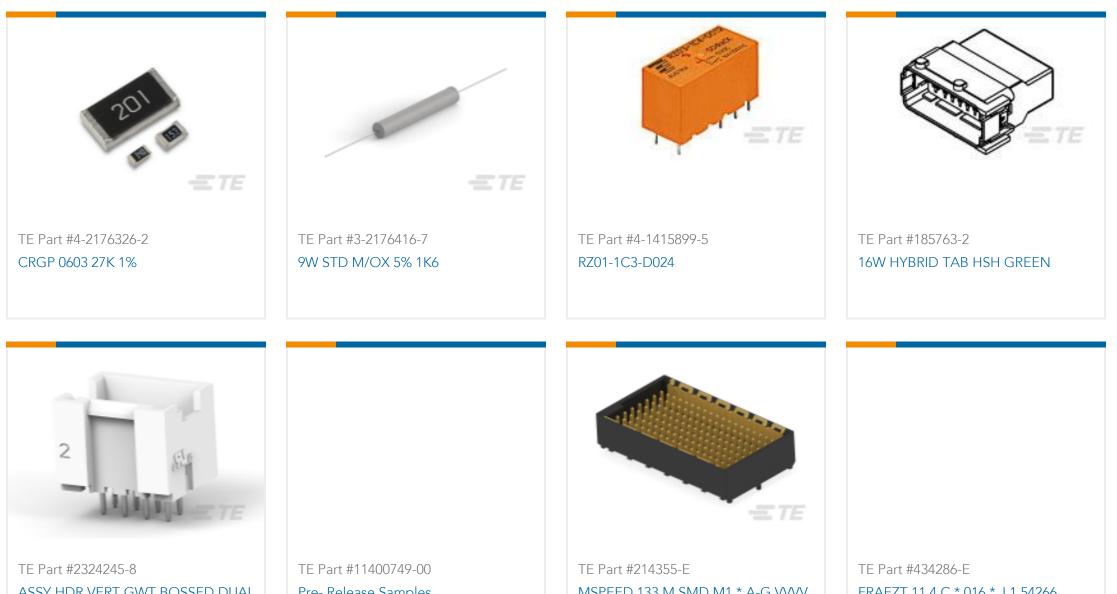
# **Compatible Parts**

SO DIMM Sockets, Double Data Rate (DDR), Stack Height .205 in [5.2 mm], Right Angle Module Orientation, 200 Position, .024 in [.6 mm] Centerline





# Customers Also Bought



ASSY,HDR,VERT,GWT,BOSSED,DUAL ROW,EP2.5	Pre- Release Samples	MSPEED 133 M SMD M1 * A-G VVVV 137 176 *	FRAEZT 11,4 C * 016 * J 1 54266 FUEHRUNG
		-	
TE Part #MS580302BA01-10	TE Part #6431-BCE-S-025-000		
MS5803-02BA 2BAR W GEL P-CAPS	PRE-RELEASE SAMPLES ONLY		

### Documents

Product Drawings SEMI HARD TRAY DDR SOCKET 200P

English

### **CAD** Files

Customer View Model

#### ENG\_CVM\_CVM\_1473005-1\_J1.2d\_dxf.zip

English

3D PDF

SO DIMM Sockets, Double Data Rate (DDR), Stack Height .205 in [5.2 mm], Right Angle Module Orientation, 200 Position, .024 in [.6 mm] Centerline



3D

Customer View Model ENG\_CVM\_CVM\_1473005-1\_J1.3d\_igs.zip English

**Customer View Model** 

ENG\_CVM\_CVM\_1473005-1\_J1.3d\_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Product Specifications Product Specification

English